

Product Compliance Declaration

Please see <u>www.molex.com</u> for the most up-to-date information.

Contact Info	ormation		
Name	Molex Product Compliance	E-Mail	Product.Compliance@molex.com
Part Inform	ation		
Part Number	0346910122	Part Weight	6.205G
Part Name	STAC64 RA HDR 12 CKT BRN POL C TRAY		

Product Composition

Name	Туре	CAS Number	Proportion (% Total)	Mass (Grams)
STAC64 RA HDR 12 CKT BRN POL C TRAY	Assembly		100	6.205
STAC64 RA HDR HOUSING 12 CKT BRN POL C	Component		78.34	4.861
PS-ST GF BROWN	Material		78.34	4.861
PS-ST	Substance		45.8703	2.846252
GF-Fibre	Substance		23.502	1.4583
Further Additives, not to declare	Substance	system	2.6368	0.163616
Boric acid	Substance	10043-35-3	0.0962	0.005969
Pigment portion, not to declare	Substance	system	0.9344	0.057977
Benzene, ethenyl-, polymer with 1,3-butadiene, hydrogenated	Substance	66070-58-4	5.3003	0.328886
0.64 X 34.93 SQ PIN BRASS REFLOW SN	Component		12.087	0.75
SQ WIRE C26000 PL 0.625 X 0.625	Material		12.087	0.75
Cartridge Brass 70% Unplated	Material		11.8388	0.734595
Copper	Substance	7440-50-8	8.2871	0.514217

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Name	Туре	CAS Number	Proportion (% Total)	Mass (Grams)
Zinc (metal)	Substance	7440-66-6	3.5516	0.220379
Copper Plating	Material		0.0237	0.001472
Copper	Substance	7440-50-8	0.0237	0.001472
Tin Plating	Material		0.1297	0.008047
Tin	Substance	7440-31-5	0.1297	0.008047
Nickel Plating	Material		0.0949	0.005887
Nickel	Substance	7440-02-0	0.0949	0.005886
Further Additives, not to declare	Substance	system	9E-06	6E-07
0.64 X 29.86 SQ PIN BRASS REFLOW SN	Component		9.5729	0.594
SQ WIRE C26000 PL 0.625 X 0.625	Material		9.5729	0.594
Cartridge Brass 70% Unplated	Material		9.3763	0.581799
Copper	Substance	7440-50-8	6.5634	0.407259
Zinc (metal)	Substance	7440-66-6	2.8129	0.17454
Copper Plating	Material		0.0188	0.001165
Copper	Substance	7440-50-8	0.0188	0.001165
Tin Plating	Material		0.1027	0.006373
Tin	Substance	7440-31-5	0.1027	0.006373
Nickel Plating	Material		0.0751	0.004662
Nickel	Substance	7440-02-0	0.0751	0.004662
Further Additives, not to declare	Substance	system	8E-06	5E-07

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ROHS Declaration Information

Regulatory Revision EU 2015/863

Compliance Status Compliant

Contained Substances Exceeding Threshold

None

Exemptions

None

REACH-SVHC Declaration Information

Regulatory Revision D(2020)9139-DC (19 Jan 2021)

Contained Substances Exceeding Threshold

Substance Group Substance Location		Threshold	Concentration	Intentionally
		(PPM)	(PPM)	Added
I BOUC ACID	STAC64 RA HDR HOUSING 12 CKT BRN POL C	1,000	1,228	Yes

GADSL Declaration Information

Regulatory Revision GADSL imported from IMDS

Contained Substances Exceeding Threshold

Substance Group	Substance Location	Threshold (PPM)	Concentration (PPM)	Intentionally Added
Boric acid	PS-ST GF BROWN	*Note	1,228	Yes
lead	Cartridge Brass 70% (CA260)	*Note	350	Yes
lead		*Note	500	Yes
nickel powder [particle diameter < 1 mm]	Ep-Ni	*Note	997,500	Yes
copper	Cartridge Brass 70% (CA260)	*Note	700,000	Yes
copper	e-plate Cu (electrodeposited Copper Coatings)	*Note	999,625	Yes

*Note: For GADSL substance declarable/prohibited threshold values, please reference http://www.gadsl.org/

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Exemptions

Part Name	Exemption
Cartridge Brass 70% (CA260)	44 Concentration within acceptable GADSL limits
	44 Concentration within acceptable GADSL limits
Ep-Ni	33 Other application (Surface not routinely touched or nickel release rate < 0.5µg/ cm2/week)

HFLH Declaration Information

Regulatory Revision IEC 61249-2-21

Contained Substances Exceeding Threshold

None

China ROHS Declaration Information

Part Number	0346910122						
Part Name	STAC64 RA HDR 12 CKT BRN POL C TRAY						
Part Informatio	n		Ha	zardous S	Substance	s	
Components		Lead	Mercury	Cadmium	Hex. Chromium	PBB	PBDE
STAC64 RA I	HDR 12 CKT BRN POL C TRAY	0	0	0	0	0	0
STAC64 RA I	HDR HOUSING 12 CKT BRN POL C	0	0	0	0	0	0
0.64 X 34.93 SQ PIN BRASS REFLOW SN		0	0	0	0	0	0
0.64 X 29.86	SQ PIN BRASS REFLOW SN	0	0	0	0	0	0

Process Information

Component Plating / Surface Finish	MSn-RNi
Termination Base Alloy	Brass
Solder Alloy	N/A
Process Capability	WAVE
Maximum Exposure Time (seconds)	040

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Limitation of this Product Compliance Declaration: This declaration is based on the state of knowledge and belief of Molex as of the date that it is provided. Molex bases its knowledge and belief on information provided by numerous sources, including third parties, and in certain circumstances laboratory test results. Molex has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and substances. Molex represents that to the best of its knowledge that the information provided in this declaration is accurate. Molex's sole liability shall be to either replace the product or refund the purchase price of the product if it does not meet the requirement of this declaration.

Maximum Process Temperature (C)	260
Maximum Cycles at Reflow Temperature	003
J-STD-020 Moisture Sensitivity Level	N/A

Mar 24, 2021

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